## 74ALVCHS162830A **1-BIT TO 2-BIT ADDRESS DRIVER** WITH 3-STATE OUTPUTS SCES624 - FEBRUARY 2005

<ul> <li>Member of the Texas Instruments Widebus™ Family</li> </ul>		PACKAGE P VIEW)
<ul> <li>Output Ports Have Series Damping Resistors, So No External Resistors Are Required</li> </ul>	2Y2 [ 1 1Y2 [ 2	80 1Y3 79 2Y3
<ul> <li>Diodes on Inputs Clamp Overshoot</li> </ul>		
	2Y1 4	<b>–</b>
<ul> <li>Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown</li> </ul>		
Resistors	V <sub>CC</sub> [ 6 A1 [ 7	
	AT L 7 A2 [ 8	
<ul> <li>Latch-Up Performance Exceeds 250 mA Per JESD 17</li> </ul>		
	A3 1 10	6
ESD Protection Exceeds JESD 22	A4 [] 11	6
<ul> <li>2000-V Human-Body Model (A114-A)</li> <li>200 V Machine Model (A115 A)</li> </ul>		
<ul> <li>200-V Machine Model (A115-A)</li> </ul>	A5 1 13	- H
description/ordering information	A6 🛛 14	
	V <sub>CC</sub> [ 15	<b>6</b>
This 1-bit to 2-bit address driver is designed for	A7 🛛 16	6
2.3-V to 3.6-V V <sub>CC</sub> operation.	A8 🛛 17	
Diodes to $V_{CC}$ have been added on the inputs to	GND [ 18	63 🛛 GND
clamp overshoot.	<u>A9</u> [ 19	· •
-	OE1 20	
Active bus-hold circuitry holds unused or undriven	OE2 21	<b>-</b>
inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not	A10 🛛 22	- E
recommended.	GND 23	
	A11 🛛 24	
The outputs, which are designed to sink up to	A12 [] 25	H
12 mA, include series damping resistors to reduce		L CC
overshoot and undershoot.	A13 27	· · ·
The ALVCHS162830A is an improved version of	A14 [ 28 GND 🗍 29	· · · 🔟
the LVCHS162830 (non-A version) and has been		· P
optimized for lower power consumption and	A15 [] 30 A16 [] 31	
higher AC drive. Higher AC drive provides		
capability to drive loads with a faster edge rate.		

To ensure the high-impedance state during power up or power down, the output-enable ( $\overline{OE}$ ) input should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

50 2Y13 49 GND 48 1Y14 A17 🛛 33 A18 47 2Y14 34 Vcc [ 46 **V**CC 35 2Y18 [ 45 ] 1Y15 36 1Y18 🛛 37 44 2Y15 GND [ 43 GND 38 2Y17 42 1Y16 39 41 2Y16 1Y17 [ 40



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# 74ALVCHS162830A **1-BIT TO 2-BIT ADDRESS DRIVER** WITH 3-STATE OUTPUTS SCES624 - FEBRUARY 2005

## description/ordering information

#### **ORDERING INFORMATION**

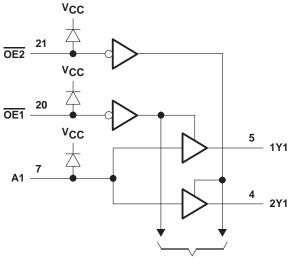
TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	TVSOP – DBB	Tape and reel	74ALVCHS162830AGR	ALVCHS162830A

<sup>†</sup>Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

	FUNCTION TABLE									
	INPUTS	OUTI	PUTS							
OE1	OE2	Α	1Yn	2Yn						
L	Н	Н	Н	Z						
L	Н	L	L	Ζ						
н	L	н г		Н						
н	L	L	Z	L						
L	L	Н	н	Н						
L	LLL		L	L						
н	Н	Х	Z	Z						

#### 

## logic diagram (positive logic)



To 17 Other Channels



## 74ALVCHS162830A **1-BIT TO 2-BIT ADDRESS DRIVER** WITH 3-STATE OUTPUTS

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ Input voltage range, $V_I$ (see Note 1) Output voltage range, $V_O$ (see Notes 1 and 2) Input clamp current, $I_{IK}$ ( $V_I < 0$ , $V_I > V_{CC}$ ) Output clamp current, $I_{OK}$ ( $V_O < 0$ ) Continuous output current, $I_O$ Continuous current through each $V_{CC}$ or GND Package thermal impedance, $\theta_{JA}$ (see Note 3) Storage temperature range Temperature	$\begin{array}{cccc} -0.5 \mbox{ V to } V_{CC} + 0.5 \mbox{ V} \\ -0.5 \mbox{ V to } V_{CC} + 0.5 \mbox{ V} \\ \pm 50 \mbox{ mA} \\ -50 \mbox{ mA} \\ \pm 50 \mbox{ mA} \\ -100 \mbox{ mA} \\ -64^{\circ}\mbox{C/W} \end{array}$
Storage temperature range, T <sub>stg</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. This value is limited to 4.6 V maximum.

3. The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
VCC	Supply voltage		2.3	3.6	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7		
VIH	High-level input voltage	$V_{CC} = 2.7 V \text{ to } 3.6 V$	2		V
	Level based Second and the sec	$V_{CC}$ = 2.3 V to 2.7 V		0.7	
VIL	Low-level input voltage	$V_{CC} = 2.7 V \text{ to } 3.6 V$		0.8	V
VI	Input voltage		0	VCC	V
VO	Output voltage		0	VCC	V
		V <sub>CC</sub> = 2.3 V		-6	
IОН	High-level output current	$V_{CC} = 2.7 V$		-8	mA
		$V_{CC} = 3 V$		-12	
		V <sub>CC</sub> = 2.3 V		6	
IOL	Low-level output current	$V_{CC} = 2.7 V$		8	mA
		$V_{CC} = 3 V$		12	
$\Delta t/\Delta v$	Input transition rise or fall rate			10	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



## 74ALVCHS162830A **1-BIT TO 2-BIT ADDRESS DRIVER** WITH 3-STATE OUTPUTS

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electrical characteristics	over	recommended	operating	free-air	temperature	range	(unless
otherwise noted)					-	•	

PARA	METER	TEST C	ONDITIONS	V <sub>CC</sub>	MIN	TYP <sup>†</sup>	MAX	UNIT	
		l <sub>l</sub> = –18 mA		2.3 V			-1.2	.,	
VIK		lj = 18 mA		2.3 V		VC	C + 1.2	V	
		I <sub>OH</sub> = -100 μA		2.3 V to 3.6 V	V <sub>CC</sub> – 0	0.2			
		$I_{OH} = -4 \text{ mA},$	V <sub>IH</sub> = 1.7 V	2.3 V	1.9				
			V <sub>IH</sub> = 1.7 V	2.3 V	1.7			.,	
VOH		I <sub>OH</sub> = -6 mA	V <sub>IH</sub> = 2 V	3 V	2.4			V	
		I <sub>OH</sub> = -8 mA,	V <sub>IH</sub> = 2 V	2.7 V	2				
		I <sub>OH</sub> = -12 mA,	V <sub>IH</sub> = 2 V	3 V	2				
		I <sub>OL</sub> = 100 μA		2.3 V to 3.6 V			0.2		
		I <sub>OL</sub> = 4 mA,	V <sub>IL</sub> = 0.7 V	2.3 V			0.4		
		VIL = 0.7 V	2.3 V			0.55	V		
VOL	VOL	I <sub>OL</sub> = 6 mA	V <sub>IL</sub> = 0.8 V	3 V			0.55	V	
		I <sub>OL</sub> = 8 mA,	V <sub>IL</sub> = 0.8 V	2.7 V			0.6		
		I <sub>OL</sub> = 12 mA,	V <sub>IL</sub> = 0.8 V	3 V			0.8		
lj		V <sub>I</sub> = V <sub>CC</sub> or GND		3.6 V			±5	μA	
		V <sub>I</sub> = 0.7 V		2.3 V	45				
		V <sub>I</sub> = 1.7 V		2.3 V	-45				
ll(hold)		V <sub>I</sub> = 0.8 V		3 V	75			μA	
.()		V <sub>I</sub> = 2 V		3 V	-75			·	
		$V_{I} = 0$ to 3.6 V <sup>‡</sup>		3.6 V			±500		
I <sub>OZ</sub>		$V_{O} = V_{CC}$ or GND		3.6 V			±10	μA	
ICC		$V_{I} = V_{CC}$ or GND,	I <sub>O</sub> = 0	3.6 V			20	μA	
∆ICC			Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			500	μA	
	Control inputs		•••	İ		3.5		_	
Ci	Data inputs	$V_{I} = V_{CC} \text{ or } GND$		3.3 V		4.5		pF	
C <sub>o</sub>	Outputs	$V_{O} = V_{CC}$ or GND		3.3 V		4.5		pF	

<sup>†</sup> All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C. <sup>‡</sup> This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO	۷ <sub>CC</sub> = ± 0.2	2.5 V 2 V	V <sub>CC</sub> =	2.7 V	۲ <mark>0.5</mark> × V <sub>CC</sub> =	3.3 V 3 V	UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> pd	А	Y	1.2	3.8		4	1.7	3.5	ns
t <sub>en</sub>	OE	Y	1	5.7		5.7	1	4.8	ns
<sup>t</sup> dis	OE	Y	1	4.9		5.4	1.7	5.2	ns

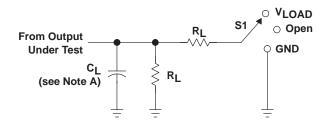
## operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST C	ONDITIONS	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V TYP	UNIT	
	Power dissipation capacitance	0.0	£ 10 MU	17	17.5	~ <b>F</b>	
Cpd	per bit (one output switching)	All outputs disabled	$C_L = 0$ , $f = 10 \text{ MHz}$		0.4	0.5	pF



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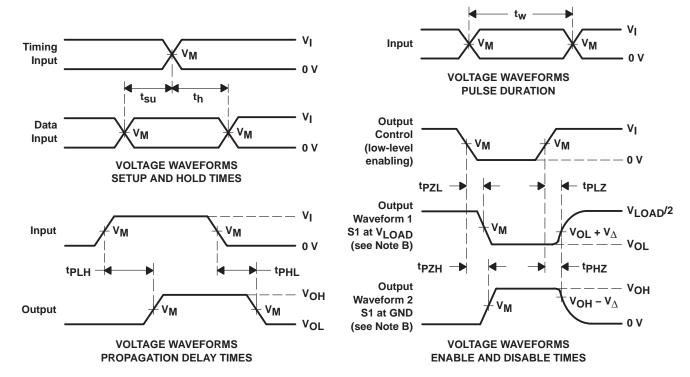
## PARAMETER MEASUREMENT INFORMATION

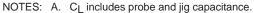


LOAD CIRCUIT

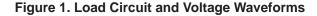
TEST	S1
<sup>t</sup> pd	Open
<sup>t</sup> PLZ <sup>/t</sup> PZL	V <sub>LOAD</sub>
<sup>t</sup> PHZ <sup>/t</sup> PZH	GND

Vee	V <sub>CC</sub> INPUT V <sub>M</sub>	Mar	Manage	0	D	V	
VCC		t <sub>r</sub> /t <sub>f</sub>	VМ	VLOAD	СL	RL	$v_\Delta$
2.5 V $\pm$ 0.2 V	Vcc	≤2 ns	V <sub>CC</sub> /2	$2 \times V_{CC}$	30 pF	<b>500</b> Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	<b>500</b> Ω	0.3 V
3.3 V $\pm$ 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	<b>500</b> Ω	0.3 V





- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
   C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω.
- An input purses are supplied by generations having the following characteristics.  $FKK \ge 10$  MHz,  $Z_0 = 0$
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G. tPLH and tPHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.







10-Dec-2020

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
74ALVCHS162830AGR	ACTIVE	TSSOP	DBB	80	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ALVCHS162830A	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(<sup>6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## PACKAGE MATERIALS INFORMATION

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## TAPE AND REEL INFORMATION

#### REEL DIMENSIONS

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TAPE AND REEL INFORMATION

#### TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
74ALVCHS162830AGR	TSSOP	DBB	80	2000	330.0	24.4	8.4	17.3	1.7	12.0	24.0	Q1

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# PACKAGE MATERIALS INFORMATION

14-Jul-2012



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
74ALVCHS162830AGR	TSSOP	DBB	80	2000	367.0	367.0	45.0	

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